

2SK1318

Silicon N Channel MOS FET High Speed Power Switching

REJ03G0930-0200

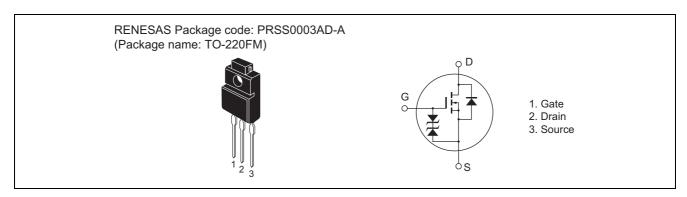
(Previous: ADE-208-1269)

Rev.2.00 Sep 07, 2005

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	120	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I _D	20	A
Drain peak current	I _{D (peak)} *1	80	A
Body to drain diode reverse drain current	I _{DR}	20	A
Channel dissipation	Pch ^{*2}	35	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25°C

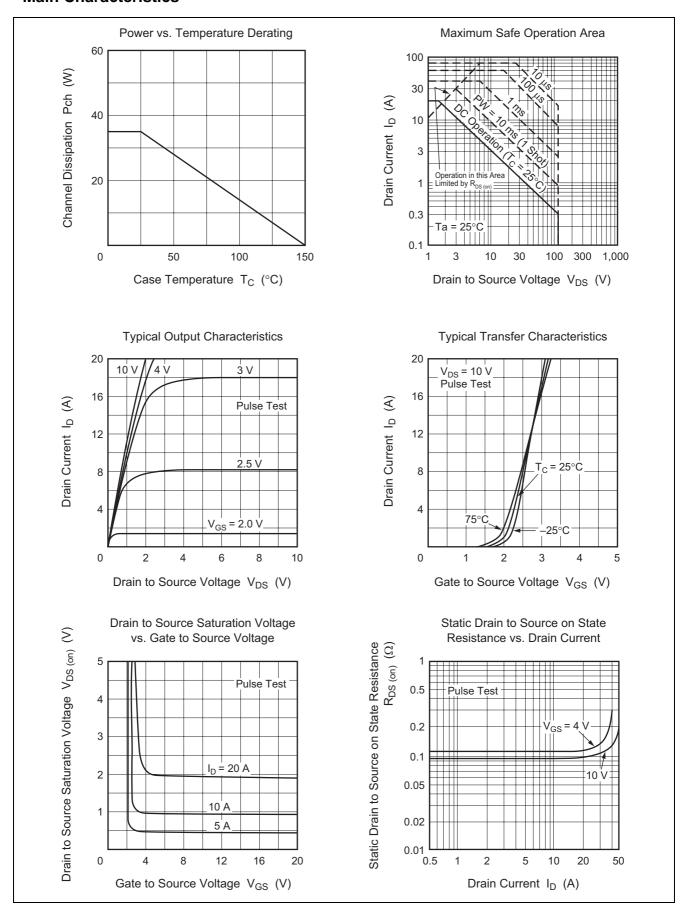
Electrical Characteristics

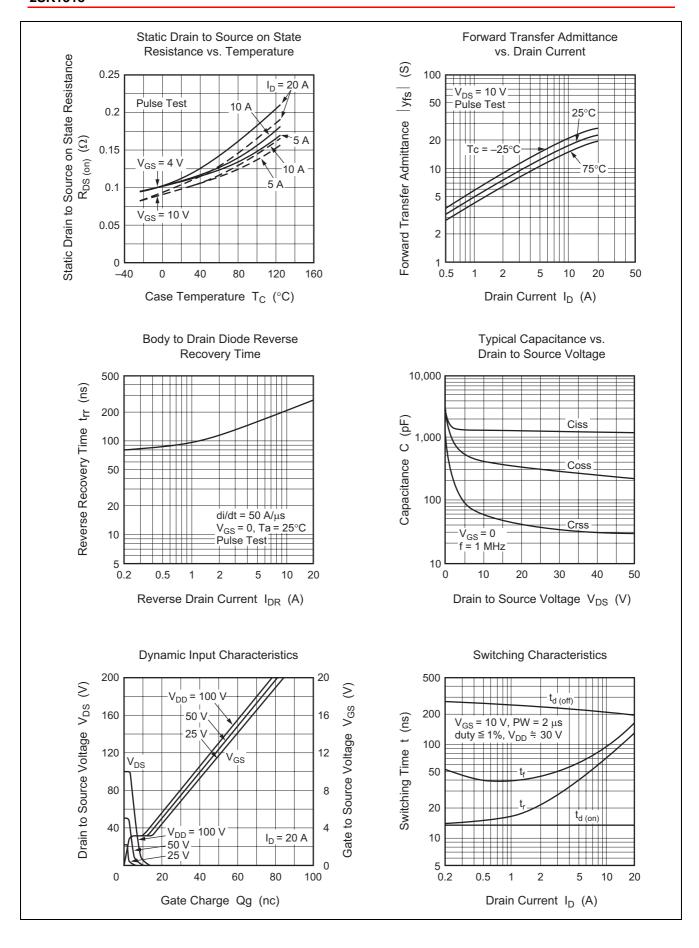
 $(Ta = 25^{\circ}C)$

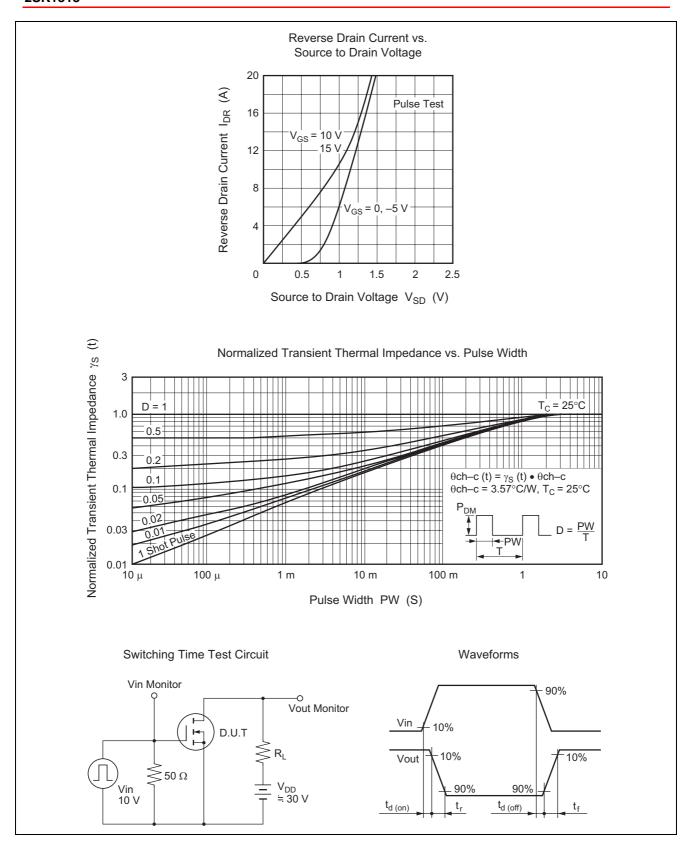
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	120	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I_{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	$V_{DS} = 100 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R _{DS(on)}	_	0.095	0.12	Ω	$I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
resistance		_	0.11	0.16	Ω	$I_D = 10 \text{ A}, V_{GS} = 4 \text{ V}^{*3}$
Forward transfer admittance	y _{fs}	10	17	_	S	$I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	Ciss	_	1300	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	430	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	60	_	pF	
Turn-on delay time	t _{d (on)}	_	14	_	ns	$I_D = 10 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	t _r	_	70	_	ns	$R_L = 3 \Omega$
Turn-off delay time	t _{d (off)}	_	210	_	ns	
Fall time	t _f	_	90	_	ns	
Body to drain diode forward voltage	V_{DF}	_	1.4	_	V	$I_F = 20 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery	t _{rr}	_	280	_	ns	$I_F = 20 \text{ A}, V_{GS} = 0,$
time						$di_F / dt = 50 A / \mu s$

Note: 3. Pulse test

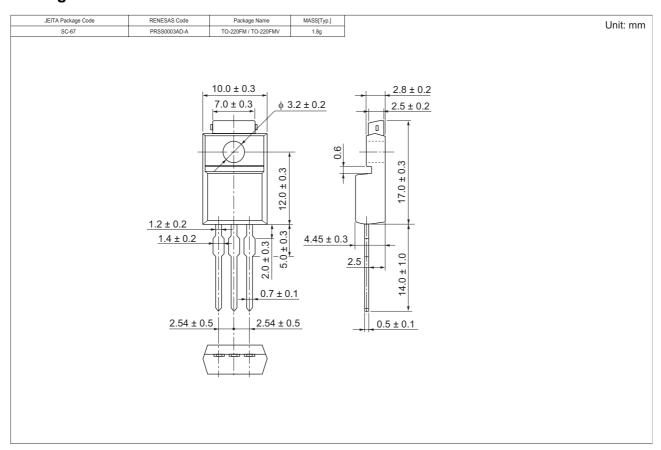
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK1318-E	500 pcs	Box (Sack)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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